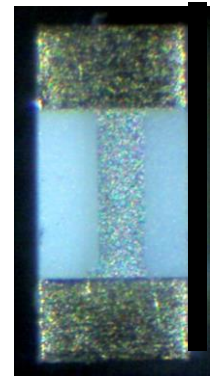


Standard Resistors with Edge Wrap

PR Series - Edge Wrap

- Half wrap style chips have solid gold back contiguous with one pad, therefore eliminating one wirebond
- Full wrap style chips have both pads continue to the back side, allowing elimination of all wirebonds
- Can be used in Non-Magnetic Applications

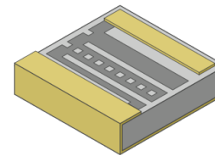


20x10 392Ω
Full Wrap Resistor

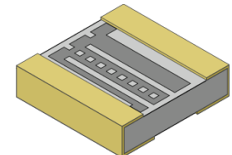
◆ Product Specifications

Resistance Range	1 Ω to 3.5 MΩ
Resistance Tolerance	±0.01% to ±20%, value dependent

Half Wrap



Full Wrap



◆ Part Numbering

Example shown below: Standard Resistor, TaN resistive element, AlN substrate, case size 0.040" × 0.020" × 0.010", dual edge wrap, resistance 200Ω ± 2%, 150 ppm TCR, 1.0 W max power handling.

P R T 1 28 - 40×20× 10 N 200R0 G Q K W

P = Passive Plus

Resistor Style

R = Standard (<500MHz)

Resistive Material

T = Tantalum Nitride
N = NiChrome

Number of Resistors

Substrate

See Charts on next page

Length and Width

See Charts on the following pages

Thickness

10 mils standard
(5 mils standard for size 12x9)

Packaging

W = Waffle Pack (Standard)*

Power Handling

See Charts on next page

TCR

See Charts on next page

Resistance Tolerance

See Charts on next page

Resistance Value

Digits 1-4 are significant figures
Digit 5 is the number of zeros to follow
When required, the "R" is used as a decimal point and the exponent is omitted.
e.g. 100R5 = 100.5Ω, 10000 = 10000Ω, 10001 = 10000Ω

Termination

See Charts on next page

* All parts are supplied in waffle packs. Other packaging may be available. Contact PPI for additional packaging options.

The standard dimensional tolerance for length and width is ± 2 mils.
The standard dimensional tolerance for thickness is ± 1 mil.

Standard Resistors with Edge Wrap

◆ Resistive Materials & Temperature Coefficient of Resistance (TCR)

Resistive Materials					TCR					
Material	Passivation	Sheet Resistivity (Ω/ Sq)	Abs. Tolerance	Ratio Tolerance	±150 ppm/°C	±100 ppm/°C	±50 ppm/°C	±25 ppm/°C	±10 ppm/°C	±5 ppm/°C
Tantalum Nitride (TaN)	Self Passivating Ta ₂ O ₅	5 to 270	From ±0.01%	From ±0.01%	Q	V	W	X	Y	Z
					Standard	Yes	---	---	---	---
NiChrome (NiCr)	SiO ₂	5 to 240	From ±0.01%	From ±0.01%	---	---	Yes	Standard	Yes	Yes

◆ Substrate Materials

Material	Thickness	Surface Finish	Dielectric Constant (@ 1MHz)	Coefficient of Thermal Expansion (x 10 ⁶ / °C)	Thermal Conductivity (W/m ² *K)	Code
Alumina (Al ₂ O ₃)	0.005" - 0.010"	2μ" - 3μ"	9.9	⁷ (25°C to < 300°C)	26.9	35
Aluminum Nitride (AlN)	0.005" - 0.010"	6μ" - 8μ"	8.0 - 9.1	^{4.6 - 5.7} (25°C to < 1000°C)	170	28
Beryllium Oxide (BeO)	0.005" - 0.010"	< 5μ"	6.76	⁹ (25°C to < 1000°C)	285	25

◆ Resistance Tolerance Codes

Tolerance*	B	D	F	G	H	J	K	L	M	Q	S
Code	± 0.1%	± 0.5%	± 1%	± 2%	± 3%	± 5%	± 10%	± 15%	± 20%	± 0.05%	± 0.01%

* Limit of ± 50mΩs

◆ Terminations

Description	Code	Application	Metallization
1 Side Wrap	H	Epoxy or Au/Sn	Ta/Pd/Au
1 Side Wrap	M	Epoxy, Au/Sn or Sn Solder	TiW/Ni/Au
1 Side Wrap	S	Sn Solder Ball	TiW/Ni/Au - solder dipped
2 Side Wrap	J	Epoxy or Au/Sn	Ta/Pd/Au
2 Side Wrap	N	Epoxy, Au/Sn or Sn Solder	TiW/Ni/Au
2 Side Wrap	T	Sn Solder Ball	TiW/Ni/Au - solder dipped

Higher power ratings, additional sizes, and custom resistors may be available.

Please contact sales@passiveplus.com.

◆ Power Handling Codes

Watts	Code	Watts	Code
50 mW	C	750 mW	J
75 mW	D	1.0 W	K
100 mW	E	1.4 W	U
125 mW	I	2.0 W	L
150 mW	F	2.8 W	Y
200 mW	O	3.0 W	N
250 mW	G	4.0 W	P
350 mW	M	5.0 W	Q
400 mW	R	6.0 W	2
500 mW	H	10 W	S

Standard Resistors with Edge Wrap

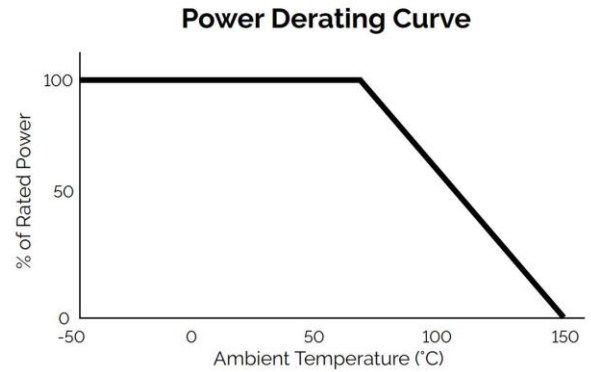
◆ Power Handling & Standard Resistance Ranges by Material and Case Size

Power Handling				Resistance Range			
Case Size mils (inches)	Alumina (C-35)	AlN (C-28)	BeO (C-25)	Min (Ω)	Max (Ω) Alumina (C-35)	Max (Ω) AlN (C-28)	Max (Ω) BeO (C-25)
12 x 9 (0.012 x 0.009)	50 mW	200 mW	400 mW	1-3	25K	25K	25K
14 x 12 (0.014 x 0.012)	100 mW	400 mW	800 mW	1-3	40K	40K	40K
20 x 10 (0.020 x 0.010)	100 mW	400 mW	800 mW	1-3	60K	60K	60K
15 x 15 (0.015 x 0.015)	100 mW	400 mW	800 mW	1-2	70K	70K	70K
20 x 20 (0.020 x 0.020)	250 mW	1.0 W	2.0 W	1-2	125K	125K	125K
30 x 20 (0.030 x 0.020)	250 mW	1.0 W	2.0 W	1-2	200K	200K	200K
40 x 20 (0.040 x 0.020)	250 mW	1.0 W	2.0 W	1-2	250K	250K	250K
30 x 30 (0.030 x 0.030)	250 mW	1.0 W	2.0 W	1-2	275K	275K	275K
35 x 35 (0.035 x 0.035)	250 mW	1.0 W	2.0 W	1-2	300K	300K	300K
40 x 40 (0.040 x 0.040)	350 mW	1.4 W	2.8 W	1-2	500K	500K	500K
50 x 25 (0.050 x 0.025)	350 mW	1.4 W	2.8 W	1-2	300K	300K	300K
60 x 30 (0.060 x 0.030)	500 mW	2.0 W	4.0 W	1-2	500K	500K	500K
50 x 50 (0.050 x 0.050)	500 mW	2.0 W	4.0 W	1-2	700K	700K	700K
60 x 60 (0.060 x 0.060)	500 mW	2.0 W	4.0 W	1-2	2M	2M	2M
80 x 50 (0.080 x 0.050)	500 mW	2.0 W	4.0 W	1-2	2M	2M	2M
100 x 50 (0.100 x 0.050)	500 mW	2.0 W	4.0 W	1-2	2.5M	2.5M	2.5M
120 x 60 (0.120 x 0.060)	750 mW	3.0 W	6.0 W	1-2	3M	3M	3M
100 x 100 (0.100 x 0.100)	750 mW	3.0 W	6.0 W	1-2	3.5M	3.5M	3.5M

Standard Resistors with Edge Wrap

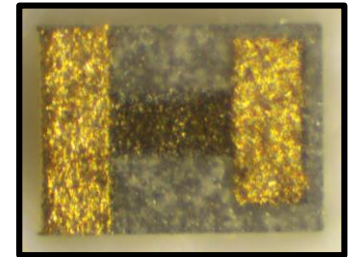
◆ General Properties

Operating Temperature	-55°C to +150°C
Storage Temperature	-65°C to +150°C
Operating Frequency	DC to 500 MHz
Voltage Rating	100V maximum
Power Derating (See Chart at Right)	Full power up to 70°C Derated linearly to zero power at 150°C



◆ Testing

Testing Performed	Specification / Standard
Visual Inspection	MIL-PRF-55342 MIL-STD-883
Mechanical Inspection	MIL-PRF-55342
DC Resistance	MIL-PRF-55342 MIL-STD-202
Resistance Temperature Characteristics (TCR)	MIL-PRF-55342
Short Time Overload	MIL-PRF-55342
High Temperature Exposure	MIL-PRF-55342
Thermal Shock	MIL-PRF-55342 MIL-STD-202
Resistance to Bonding Exposure	MIL-PRF-55342
Wire Bonding Integrity	MIL-PRF-55342
Life Test	MIL-PRF-55342 MIL-STD-202



◆ Performance Specifications

Typical PPI commercial testing includes 100% visual inspection, 100% electrical testing and TCR sampling. Our parts meet or exceed additional MIL-PRF-55342 and MIL-STD-202 requirements.

◆ Packaging

ESD waffle packs are standard. Film rings and gel pack packaging may be available upon request.

